

N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _C = +25°C
	5.0mΩ @ V _{GS} = 10V	70A
24V	$6.5 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	60A
	10.0mΩ @ V _{GS} = 2.5V	45A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

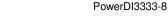
- Backlighting
- Power Management Functions
- DC-DC Converters

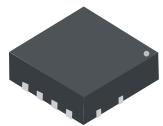
Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

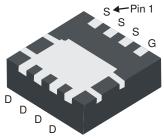
Mechanical Data

- Case: PowerDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ^{©3}
- Weight: 0.072 grams (Approximate)

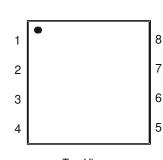




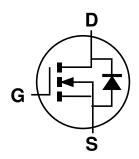
Top View



Bottom View



Top View Internal Schematic



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging		
DMT2004UFG-7	PowerDI3333-8	2,000/Tape & Reel		
DMT2004UFG-13	PowerDI3333-8	3,000/Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SF2 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	24	V
Gate-Source Voltage			V_{GSS}	±12	V
Continuous Drain Current (Note 7) $V_{GS} = 10V$ Steady $T_C = +25^{\circ}C$ State $T_C = +70^{\circ}C$		I _D	70 55	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	90	Α		
Continuous Source-Drain Diode Current (Note 6)			Is	2.5	Α
Avalanche Current (Note 8) L = 0.1mH			I _{AS}	26	Α
Avalanche Energy (Note 8) L = 0.1mH			Eas	36	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P_{D}	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ hetaJA}$	106	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ hetaJA}$	54	°C/W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	3.5	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

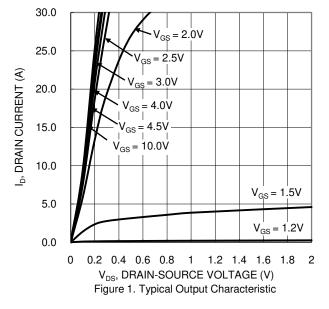
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	24	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current (T _J = +25°C)	I _{DSS}	_	_	1	μΑ	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	$V_{GS(TH)}$	0.55	_	1.45	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
	RDS(ON)	_	3.7	5.0	mΩ	$V_{GS} = 10V, I_D = 12A$	
Static Drain-Source On-Resistance		_	4.5	6.5		$V_{GS} = 4.5V, I_D = 12A$	
		_	7.5	10.0		$V_{GS} = 2.5V, I_D = 12A$	
Diode Forward Voltage	V _{SD}	_	0.65	1.0	V	V _{GS} = 0V, I _S = 2A	
DYNAMIC CHARACTERISTICS (Note 10)			•	•		•	
Input Capacitance	C _{iss}	_	1683	_		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	581	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	559	_			
Gate Resistance	Rg	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	29.6	_			
Total Gate Charge (V _{GS} = 10V)	Qq	_	53.7	_	nC	$V_{DD} = 15V, I_D = 9A$	
Gate-Source Charge	Q _{gs}	_	4.2	_	IIC		
Gate-Drain Charge	Q _{qd}	_	13.4	_			
Turn-On Delay Time	t _{D(ON)}	_	3.9	_		$V_{DD} = 15V, V_{GS} = 10V,$ $R_{G} = 3\Omega, I_{D} = 9A$	
Turn-On Rise Time	t _R	_	9.6	_			
Turn-Off Delay Time	t _{D(OFF)}	_	30.8	_	ns		
Turn-Off Fall Time	t _F	_	38.6	_			
Reverse Recovery Time	t _{RR}	_	11.2	_	ns	1 4 54 -11/-14 4004/-	
Reverse Recovery Charge	Q _{RR}	_	22.9	_	nC	I _F = 1.5A, di/dt = 100A/μs	

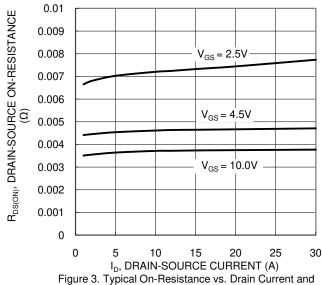
Notes:

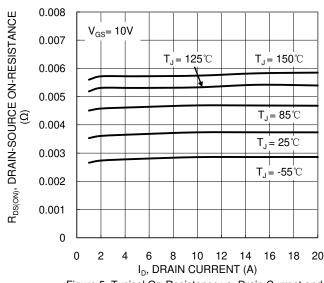
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
 9. Short duration pulse test used to minimize self-heating effect.
 10. Guaranteed by design. Not subject to product testing.





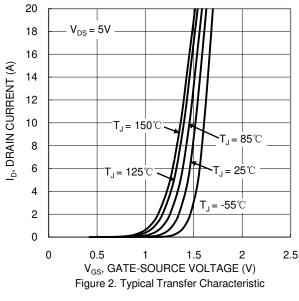


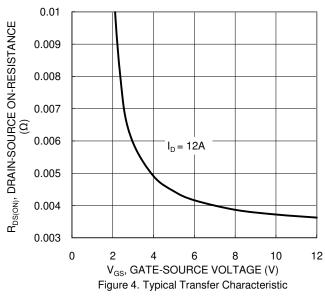




Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature





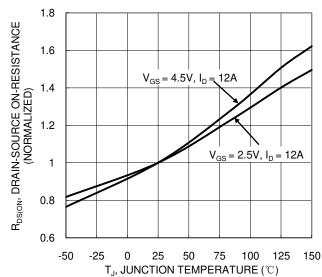


Figure 6. On-Resistance Variation with Temperature





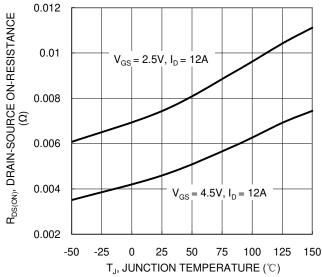
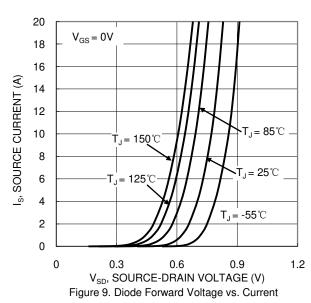
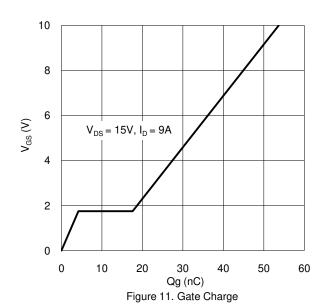


Figure 7. On-Resistance Variation with Temperature





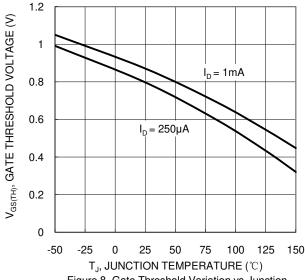
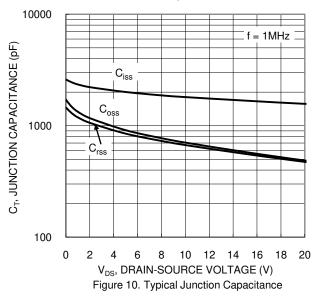
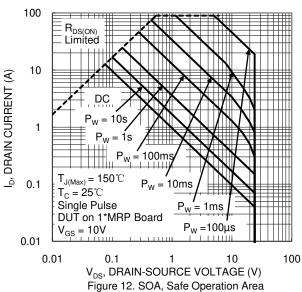
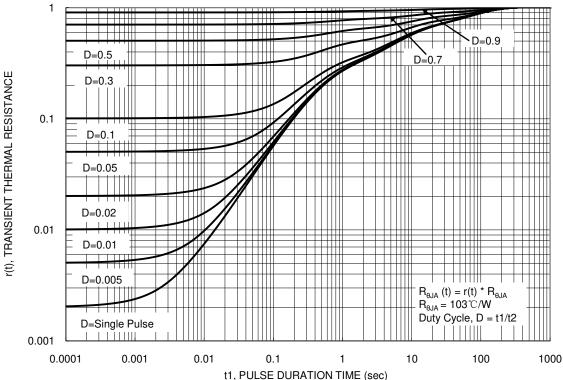


Figure 8. Gate Threshold Variation vs. Junction Temperature







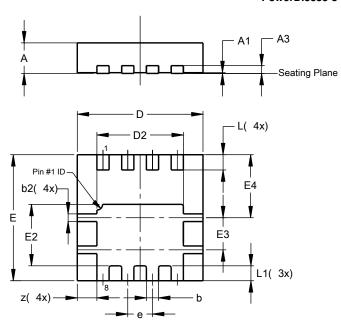




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

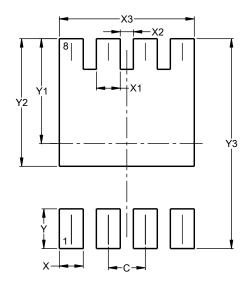


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	-	-	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
V٦	3 700



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